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U.S. Department of Commerce
Patent and Trademark Office
Attorney Docket No. 08954.0012
Attorney Customer Number: 22,852

12.23.03



102639203

TTN. BOX ASSIGNMENTS RECORDATION
SERVICES

To the Honorable Commissioner of Patents
Please record the attached original document

1. Name of conveying party(ies):
1) Cheng Che PAN
2) Sung Soo PARK

2. Name and address of receiving party(ies):
Name: CHI MEI OPTOELECTRONICS CORP.

Additional name(s) of conveying party(ies) attached? Yes No

Internal Address:

3. Nature of conveyance:

Street Address: No. 1, Chi-Yeh Road, Shin-Shih Village,
Tainan Science-Based Industrial Park,
Tainan County, Taiwan

Assignment Merger

City:

Security Agreement Change of Name

State:

Zip Code:

Other:

Additional name(s) & Address(es) attached?

Execution Date: August 28, 2003

Yes

No

17497 U.S. PTO
10743456
122103

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application: August 28, 2003

A. Patent Application Number(s): 10743456

B. Patent Number(s):

Additional numbers attached?

Yes

No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

6. Total number of applications and registrations involved:
1

7. Total fee (37 CFR 3.41): \$40

Enclosed (Please charge deficiency to deposit account)

Authorized to be charged to deposit account

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

Street Address: 1300 I Street, N.W.

City: Washington, D.C.

State: Zip: 20005-3315

8. Deposit Account No.: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Richard V. Burgujian
Reg. No. 31,744

Signature

December 23, 2003
Date

Total number of pages including cover sheet, attachments and documents: 2

12/31/2003 WABRHAM1 00000053 10743456

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Attorney Docket No.

Docket No.:

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- (1) Cheng Che PAN (4) _____
- (2) Sung Soo PARK (5) _____
- (3) _____ (6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

Chi Mei Optoelectronics Corp.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

CURING METHOD AND APPARATUS

- (a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____; or
- (b) for which an application for United States Letters Patent was executed on August 28, 2003,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside our signatures:

INVENTORS	DATE SIGNED
1) Signature: <u>Cheng Che Pan</u> Name: <u>Cheng Che PAN</u>	<u>August 28, 2003</u>
2) Signature: <u>[Signature]</u> Name: <u>Sung Soo PARK</u>	<u>August 28, 2003</u>
3) Signature: _____ Name: _____	_____
4) Signature: _____ Name: _____	_____
5) Signature: _____ Name: _____	_____
6) Signature: _____ Name: _____	_____